

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: KAWAGOE, et al.
Serial No.: (Divisional application of Serial No. 09/513,349)
Filed: December 14, 2001
For: PROCESS FOR MANUFACTURING A
SEMICONDUCTOR WAFER, A SEMICONDUCTOR
WAFER, PROCESS FOR MANUFACTURING A
SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE,
AND SEMICONDUCTOR INTEGRATED CIRCUIT
DEVICE

TERMINAL DISCLAIMER

Assistant Commissioner for Patents
Washington, D.C. 20231

December 14, 2001

Sir:

Petitioner, Hitachi, Ltd., having its place of business at 6, Kanda
Surugadai 4-chome, Chiyoda-ku, Tokyo 100, Japan, represents that it is the sole
owner of the entire interest of the above-identified application (which is a
Divisional application of Serial No. 09/513,349, filed February 25, 2000), filed
December 14, 2001, for PROCESS FOR MANUFACTURING A
SEMICONDUCTOR WAFER, A SEMICONDUCTOR WAFER, PROCESS
FOR MANUFACTURING A SEMICONDUCTOR INTEGRATED CIRCUIT
DEVICE, AND SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE, and

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TERMINAL DISCLAIMER
APPROVED

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SPECIAL PROGRAM CENTER

that the Assignment of all rights in connection therewith has been recorded at Reel 8727, Frame 0254.

Petitioner hereby disclaims all that portion of the term of any patent to be issued on the above-identified application subsequent to the expiration date of the full statutory term, defined in 35 U.S.C. 154 to 156 and 173, of U.S. Patent No. 6,043,114 issued March 28, 2000, and hereby agrees that any patent issued on the above-identified application shall be enforceable only for and during such time as the said U.S. Patent No. 6,043,114 and the above-identified application are commonly owned.

Petitioner, however, does not disclaim the terminal part of any patent granted on the instant application prior to the expiration date of the full statutory term, defined in 35 U.S.C. 154 to 156 and 173, of the above-listed U.S. Patent No. 6,043,114 in the event that U.S. Patent No. 6,043,114 expires: for failure to pay a maintenance fee; is held unenforceable; is found invalid; is statutorily disclaimed in whole or terminally disclaimed under 37 CFR 1.321; has all claims cancelled by a reexamination certificate; is reissued; or is otherwise terminated prior to expiration of the above-referred-to full statutory term, except for the separation of legal title as stated above.

This disclaimer is to be binding with respect to any patent granted on the above-identified application, and is binding upon grantees, their successors, or

assignees of any interests.

The undersigned is an attorney of record in this application and is empowered to act on behalf of Hitachi, Ltd. for execution and submission of Terminal Disclaimers, in accordance with the provisions of 37 CFR 1.321(b) and (c), effective January 4, 1994.

The undersigned hereby declares that all statements made herein of his knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine, or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Respectfully Submitted,

Antonelli, Terry, Stout & Kraus, LLP

A handwritten signature in black ink, appearing to read "William I. Solomon". The signature is fluid and cursive, with a long horizontal stroke extending to the right.

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